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Part Number:

5015914411

Status:

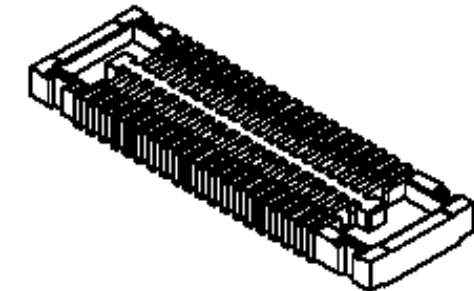
Active

Overview:

slimstack_mm016_pitch

Description:

0.40mm (.016") Pitch SlimStack™ Board-to-Board Receptacle, SMT, Dual Row, Vertical Stacking, 0.90mm (.035") Stacking Height, With Solder Tabs, 44 Circuits



Series

image - Reference only

Documents:

- [3D Model](#)
- [Drawing \(PDF\)](#)
- [Product Specification PS-501591-002 \(PDF\)](#)
- [Product Specification PS-501591-003 \(PDF\)](#)
- [RoHS Certificate of Compliance \(PDF\)](#)

General

Product Family	PCB Receptacles
Series	501591
Application	Board-to-Board
Overview	slimstack_mm016_pitch
Product Name	SlimStack™

Physical

Circuits (Loaded)	44
Color - Resin	Black
Durability (mating cycles max)	20
Glow-Wire Compliant	No
Lock to Mating Part	Yes
Mated Height (in)	0.035 In
Mated Height (mm)	0.90 mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Number of Rows	2
Orientation	Vertical
PCB Locator	No
PCB Retention	Yes
Packaging Type	Embossed Tape on Reel
Pitch - Mating Interface (in)	0.016 In
Pitch - Mating Interface (mm)	0.40 mm
Polarized to Mating Part	No
Polarized to PCB	No
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-25°C to +85°C
Termination Interface: Style	Surface Mount

Electrical

Current - Maximum per Contact	0.3A
Voltage - Maximum	50V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Packaging Specification	SPK-501591-001
Product Specification	PS-501591-002, PS-501591-003, RPS-501591-010, RPS-501591-012, RPS-501591-016, RPS-501591-019, RPS-501591-020
Sales Drawing	SD-501591-005, SD-501591-006

EU RoHS

ELV and RoHS
Compliant
REACH SVHC
Not Reviewed
Halogen-Free
Status

China RoHS



Need more information on product
environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

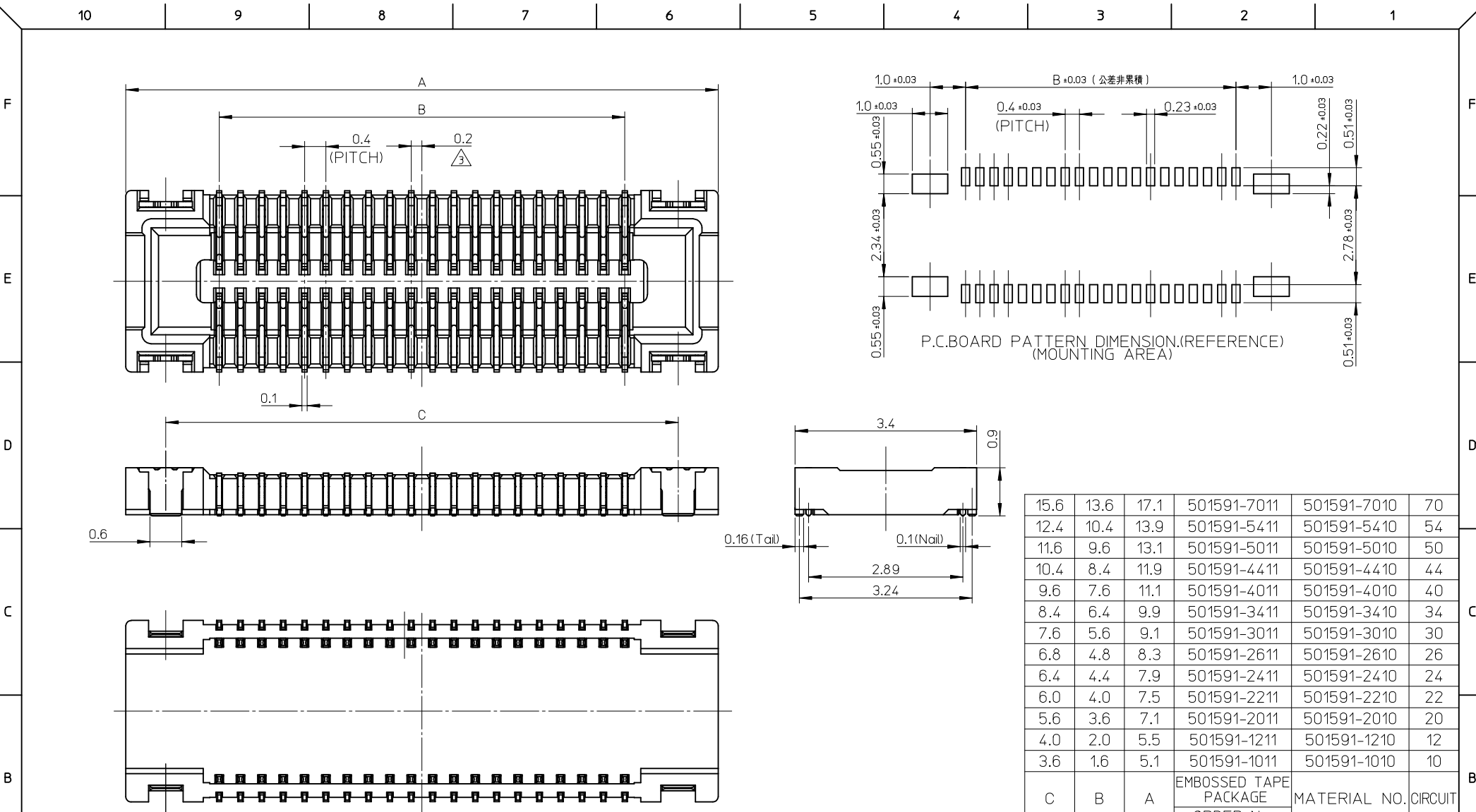
Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
501591Series

Mates With
501594 PCB Header

This document was generated on 05/24/2010

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REVISED EC NO: J2008-3370 2008/06/17 DRWK/SETO 2008/06/17 CHKD/MSASAO 2008/06/25 APPR/MSASAO	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.2	DRAWN BY TASAKAWA	DATE 2006/07/10	TITLE 0.4MM PITCH B/B CONN. H=0.9 W=3.4 REC ASSY				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2006/07/10					
		30 OVER	± 0.3	APPROVED BY MSASAO	DATE 2006/07/10	MOLEX INCORPORATED				
		ANGULAR	± 3 °	MATERIAL NO.						
	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		SD-501591-005			1 OF 2	
		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

注記 NOTES

1.使用材料
MATERIAL

ハウジング：液晶ポリマー（LCP） ガラス充填 UL-94V-0（黒）
HOSING：LIQUID CRYSTAL POLYMER (GLASS FILLED) UL94V-0 (COLOR:BLACK)

ターミナル：りん青銅（t=0.1）
TERMINAL：PHOSHOR BRONZE (t=0.1)

金具：りん青銅（t=0.1）
FITTING NAIL：PHOSHOR BRONZE (t=0.1)

2.メッキ仕様
PLATING

ターミナル
TERMINAL

金メッキ 0.1マイクロメートル以上（コンタクト部）
GOLD 0.1 MICROMETER MINIMUM (CONTACT AERA)

金メッキ 0.05マイクロメートル以上（テール部）
GOLD 0.05 MICROMETER MINIMUM (TAIL AERA)

下地メッキ：ニッケルメッキ 1.0 マイクロメートル以上
UNDER PLATING：NICKEL 1.0 MICROMETER MINIMUM

金具

FITTING NAIL

錫メッキ：1.0マイクロメートル以上
TIN PLATING：1.0 MICROMETER MINIMUM

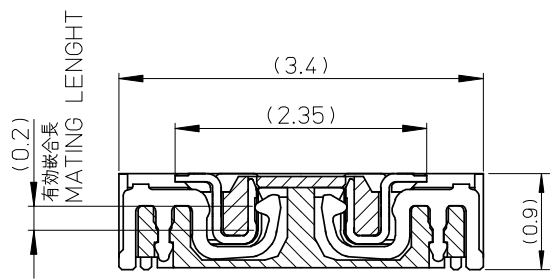
下地メッキ：ニッケル 1.0マイクロメートル以上
UNDER PLATING：NICKEL 1.0 MICROMETER MINIMUM

△3（全極数/2）=偶数の場合に適用
APPLY FOR (CIRCUIT/2)=EVEN

4.嵌合相手：501594-**10シリーズ
WITH MATE：501594-**10SERIES

5.テール及び金具の平坦度は、0.1以下
TAIL AND FITTING NAIL COPLANARITY TO BE 0.1 MAXIMUM

6.ELV AND RoHS COMPLIANT.



嵌合断面図（参考）
MATED DRAWING

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		ANGULAR ±3 °		MATERIAL NO. SEE SHEET 1		DOCUMENT NO. SD-501591-005			SHEET NO. 2 OF 2	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						
				SIZE A3						

